



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial No: 10/621,987 *Fee Only*
Filing Date: 07/16/2003
Examiner: SOWARD, IDA M
Title: SUBSTRATE STRUCTURE FOR AN INTEGRATED CIRCUIT PACKAGE
AND METHOD FOR MANUFACTURING THE SAME

Docket No: 2011118
Applicant: Jackson Hsieh
Art Unit: 2822

To: Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RESPONSE TO OFFICE ACTION

Dear Sir:

In response to the Office Action dated 03/12/2004, Applicant submits the following.

ELECTION

1. Applicant elects to restrict this application to the species designated by the Examiner as Species I, relating to Figs. 1-5, and directed to claims 1-3 and 5-6.

Respectfully submitted,

Date: April 13, 2004

Registration No: 32,737
Telephone: (408) 778-3440


Keith Kline
PRO-TECHTOR INTERNATIONAL
20775 Norada Court
Saratoga, CA 95070-3018

CERTIFICATE OF MAILING (37 CFR 1.8a): I hereby certify that this paper (along with any referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Date: April 13, 2004


Keith Kline

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